WO 2005/031780 PCT/US2004/031221

-11-

Claims

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- A tunnel diode in which the collector comprises a band gap material, said band gap material being a crystal material having filled zero temperature valence band and empty conductive band.
- 5 2. The tunnel diode of claim 1 additionally comprising an emitter coated with a layer of a band gap material.
 - 3. The tunnel diode of claim 1 or claim 2 in which the collector comprises a layer of band gap material deposited on a metal collector.
- 4. The tunnel diode of claim 3 in which said layer of material has a

 10 thickness greater than the mean distance of relaxation of electrons tunneling from said emitter.
 - 5. The tunnel diode of any of the preceding claims in which the band gap material is selected from the group consisting of: a semiconductor, a hetero-structured semiconductor, a dielectric, a diamond material, an alkali metal oxide and an alkaline earth oxide.
 - 6. The tunnel diode ofany of the preceding claims in which the band gap material is selected from the group consisting of: Ge, Si, GaAs, SiC and AlGaAs.
- 7. The tunnel diode of any of the preceding claims in which the electrodes are separated by a gap in the range 1 100nm.
 - 8. The tunnel diode of claims 1 to 6 in which the electrodes are separated by a gap in the range 1 10nm.
 - 9. The tunnel diode of claims 1 to 6 in which a gap between the emitter and collector electrodes is evacuated.
- 25 10. A vacuum diode heat pump comprising the tunnel diode of any of the preceding claims.
 - 11. A heat to electricity converter comprising the tunnel diode of claims 1 to 9.

WO 2005/031780 PCT/US2004/031221

-12-

12. A method for promoting the tunneling of electrons having an energy level higher than the Fermi level from an emitter surface, comprising the step of positioning a collector comprising a band gap material at a distance within the tunneling range of said electrons, said band gap material being a crystal material having filled zero temperature valence band and empty conductive band.

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- 13. A method for preventing back tunneling of electrons in a tunnel diode comprising the step of coating a collector with a layer of a band gap material, said band gap material being a crystal material having filled zero temperature valence band and empty conductive band.
 - 14. The method of claims 12 and 13 in which the collector comprises a layer of band gap material deposited on a metal collector.
- 15. The method of claim 14 in which said layer of material has a thickness greater than the mean distance of relaxation of electrons tunneling from said emitter.
 - 16. The method of claims 12 to 15 in which the band gap material is selected from the group consisting of: a semiconductor, a hetero-structured semiconductor, a dielectric, a diamond material, an alkali metal oxide and an alkaline earth oxide.
- 17. The method of claims 12 to 15 in which the band gap material is selected from the group consisting of: Ge, Si, GaAs, SiC and AlGaAs.
 - 18. The method of claims 12 to 17 in which the electrodes are separated by a gap in the range 1 100nm.
- 19. The method of claims 12 to 15 in which the electrodes are separated by a gap in the range 1 10nm.
 - 20. The method of claims 12 to 15 in which a gap between the emitter and collector electrodes is evacuated.